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# AMC7135

### DESCRIPTION

The AMC7135 is a low dropout current regulator rated for 350mA constant sink current. The low quiescent current and low dropout voltage are achieved by advanced Bi-CMOS process.

## **350mA Advanced Current Regulator**

#### FEATURES

- **350mA constant sink current.**
- Output short / open circuit protection.
- Low dropout voltage.
- Low quiescent current
- Supply voltage range 2.7V ~ 6V
- 2KV HBM ESD protection
- Advanced Bi-CMOS process.
- SOT-89 and TO-252 package

## TYPICAL APPLICATION CIRCUIT

#### **APPLICATIONS**

Power LED driver Cap Lamp **Refrigerator Lighting** 2.7V ~ 6V VINO PACKAGE PIN OUT CIN K. VDD AMC7135 OUT GND GND GND Co OUT ⊐ OUT **SOT-89** TO-252 (Top View)

ORDER INFORMATION							
т	PK -	SOT-89	SJ	TO-252			
I <sub>OUT</sub>		3-pin		3-pin			
340-380mA		AMC7135PKF		AMC7135SJF			
300-340mA		AMC7135PKFA		AMC7135SJFA			
Note: 1. All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number (i.e. AMC7135PKFAT).   2. The letter "F" is marked for Lead Free process.   3. The letter "A" is marked for current ranking.							

# AMC7135

ABSOLUTE MAXIMUM RATINGS (Note)	
Input Voltage, V <sub>DD</sub>	-0.3V to 7V
Output Voltage, V <sub>OUT</sub>	-0.3V to 7V
Maximum Junction Temperature, T <sub>J</sub>	150°C
Storage Temperature Range	-40°C to 150°C
Lead Temperature (Soldering, 10 seconds)	260°C
Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.	

## ABSOLUTE MAXIMUM RATINGS (Note)

BLOCK DIAGRAM
VDD Band-gap Reference Control Circuit GND

Pin Name	Pin Function
V <sub>DD</sub>	Power supply.
OUT	Output pins. Connected to load.
GND	Ground.

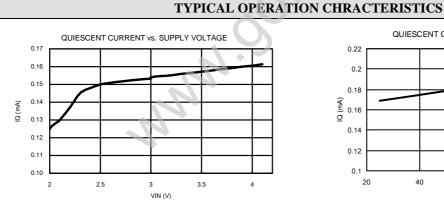
# AMC7135

RECOMMENDED OPERATING CONDITIONS								
Parameter	Symbol	Min	Тур	Max	Unit			
Supply Voltage	V <sub>DD</sub>	2.7		6	V			
Output Sink Current	I <sub>OUT</sub>			400	mA			
Operating Free-air Temperature Range	T <sub>A</sub>	-40		+85	°C			

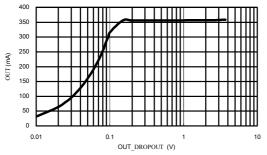
#### DC ELECTRICAL CHARACTERISTICS

	(						
Parameter	Symbol	Condition	Min	Тур	Max	Unit	Apply Pin
Ordered Sink Comment	т	V <sub>OUT</sub> =0.2V	340	360	380	mA	
Output Sink Current	I <sub>SINK</sub>	V <sub>OUT</sub> =0.2V, Rank A	300	320	340	mA	
Load Regulation		$V_{OUT}=0.2V$ to $3V$			3	mA/V	OUT
Line Regulation		$V_{DD}$ = 3V to 6V, $V_{OUT}$ =0.2V	$\mathbf{C}$		3	mA/V	001
Output Dropout Voltage	V <sub>OUTL</sub>			120		mV	
Supply Current Consumption	I <sub>DD</sub>	X		200		uA	VDD

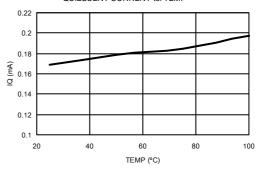
Note 1: Output dropout voltage: 90% x I<sub>OUT</sub> @ V<sub>OUT</sub>=200mV



OUT CURRENT vs.OUT\_DROPOUT VOLTAGE



QUIESCENT CURRENT vs. TEMP



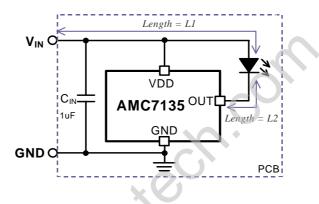
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# AMC7135

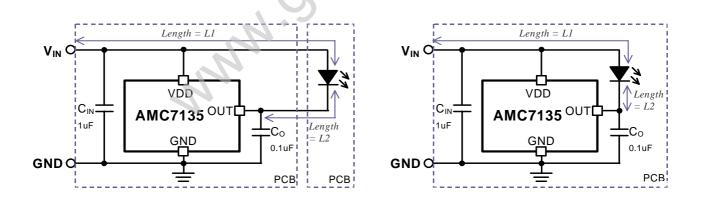
#### **APPLICATION INFORMATION**

### **Output Capacitor Co and PCB layout:**

The output capacitor  $C_0$  may be removed under certain condition. Please refer to the following figure. If LED and AMC7135 is located in the same PCB, and the length of the routing path L1<10cm & L2<3cm, the output capacitor  $C_0$  can be neglected.



If LED and AMC7135 is located in separate PCBs, or the length of the routing path L1>10cm or L2>3cm, the output capacitor  $C_0$  should be added.



## AMC7135

### The Maximum Power Dissipation on Regulator:

 $P_{D(MAX)} = V_{OUT(MAX)} \times I_{OUT(NOM)} + V_{IN(MAX)} \times I_Q$ 

 $V_{OUT(MAX)}$  = the maximum voltage on output pin;

 $I_{OUT(NOM)}$  = the nominal output current;

 $I_Q$  = the quiescent current the regulator consumes at  $I_{OUT(MAX)}$ ;

 $V_{IN(MAX)}$  = the maximum input voltage.

#### **Thermal Consideration:**

The maximum junction temperature ratings of AMC7135 should not be exceeded under continuous normal load conditions. When power consumption is over about 700mW (SOT-89 package, at  $T_A=70^{\circ}$ C) or 1000mW (TO-252 package, at  $T_A=70^{\circ}$ C), additional heat sink is required to control the junction temperature below 120°C.

The junction temperature is:

$$T_{J} = P_{D} \left( \theta_{JT} + \theta_{CS} + \theta_{SA} \right) + T_{A}$$

P<sub>D</sub>: Dissipated power.

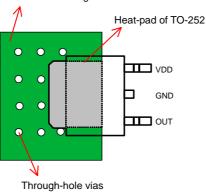
 $\theta_{\rm JT}$ : Thermal resistance from the junction to the mounting tab of the package.

For SOT-89 package,  $\theta_{JT} = 35.0^{\circ}$ C /W. For TO-252 package,  $\theta_{JT} = 7.0^{\circ}$ C /W.

- $\theta_{CS}$ : Thermal resistance through the interface between the IC and the surface on which it is mounted. (typically,  $\theta_{CS} < 1.0^{\circ}$ C/W)
- $\theta_{SA}$ : Thermal resistance from the mounting surface to ambient (thermal resistance of the heat sink).

If PC Board copper is going to be used as a heat sink, below table can be used to determine the appropriate size of copper foil required. For multi-layered PCB, these layers can also be used as a heat sink. They can be connected with several through-hole vias.

PCB $\theta$ sa (°C/W)	59	45	38	33	27	24	21
PCB heat sink size (mm <sup>2</sup> )	500	1000	1500	2000	3000	4000	5000



#### Recommended figure of PCB area used as a heat sink.

# AMC7135

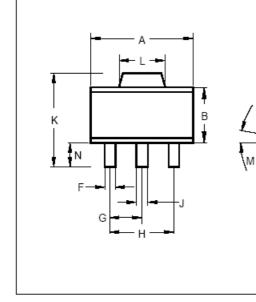
#### PACKAGE

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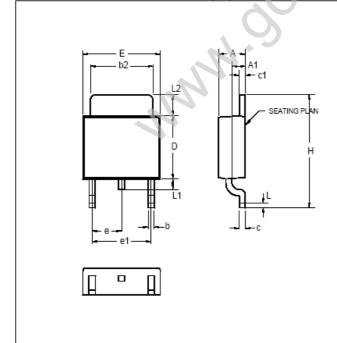
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## 3-Pin Surface Mount SOT-89



	1	NCHES	6	MILLIMETERS			
	MIN TYP MAX		MAX	MIN	TYP	MAX	
А	0.173	-	0.181	4.39	-	4.59	
В	0.090	-	0.102	2.28	-	2.59	
С	0.055	-	0.063	1.39	-	1.60	
D	0.015	-	0.017	0.38	-	0.43	
Е	0.084	-	0.090	2.13	-	2.28	
F	0.016		0.019	0.33	-	0.48	
G	0.	059 BS	iC	1.49 BSC			
Н	0.	118 BS	C	2.99 BSC			
J	0.018	-	0.022	0.45	-	0.55	
К	0.155	-	0.167	3.94	-	4.24	
L	0.067	-	0.072	1.70	-	1.82	
М	0°	-	8°	0°	-	8°	
Ν	0.035	-	0.047	0.89	-	1.19	

### 3-Pin Surface Mount TO-252 (SJ)



		NCHES	\$	MII	LIMETE	RS
	MIN	TYP	MAX	MIN	TYP	MAX
А	0.086	-	0.094	2.18	-	2.39
A1	0.040	-	0.050	1.02	-	1.27
b	-	0.024	-	-	0.61	-
b2	0.205	-	0.215	5.21	-	5.46
с	0.018	-	0.023	0.46	-	0.58
c1	0.018	-	0.023	0.46	-	0.58
D	0.210	-	0.220	5.33	-	5.59
Е	0.250	-	0.265	6.35	-	6.73
е	0.	.090 BS	C	2.29 BSC		
e1	0.	180 BS	C	4.58 BSC		
Н	0.370	-	0.410	9.40	-	10.41
L	0.020	-	-	0.51	-	-
L1	0.025	-	0.040	0.64	-	1.02
L2	0.060	-	0.080	1.52	-	2.03

## AMC7135



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ADDtek Corp. 9F, No. 20, Sec. 3, Bade Rd., Taipei, Taiwan, 105 TEL: 2-25700299 FAX: 2-25700196

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